

3.5 x2.8mm SMD CHIP LED LAMP

Part Number: APETD3528CGCK

Green

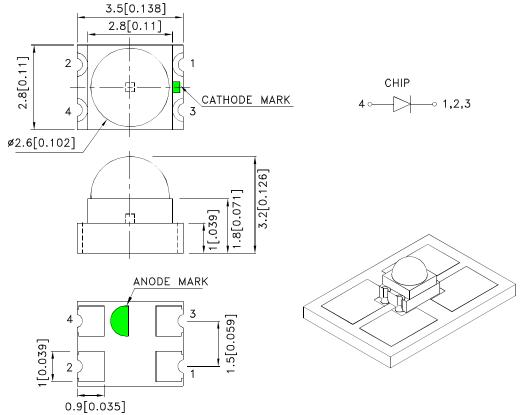
Features

- Single color.
- Suitable for all SMT assembly and solder process.
- Available on tape and reel.
- Package: 500pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

DATE: APR/18/2011 SPEC NO: DSAK7117 **REV NO: V.2** PAGE: 1 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** ERP: 1203011220 DRAWN: J.Yu

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		,	Min.	Тур.	201/2
APETD3528CGCK	Green (AlGaInP)	Water Clear	80	200	60°

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	574		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	570		nm	I=20mA
Δλ1/2	Spectral Line Half-width	Green	20		nm	IF=20mA
С	Capacitance	Green	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	2.1	2.5	V	I=20mA
lR	Reverse Current	Green		10	uA	V _R =5V

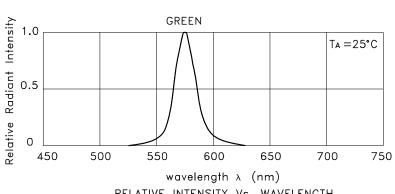
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units	
Power dissipation	75	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

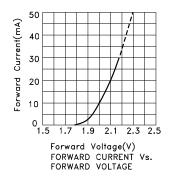
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

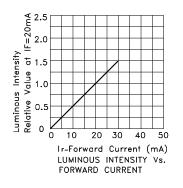
DATE: APR/18/2011 SPEC NO: DSAK7117 **REV NO: V.2** PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: J.Yu ERP: 1203011220

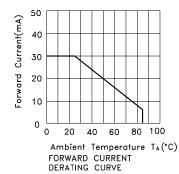


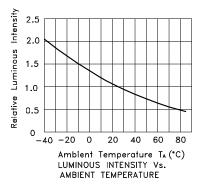
RELATIVE INTENSITY Vs. WAVELENGTH

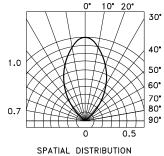
Green APETD3528CGCK









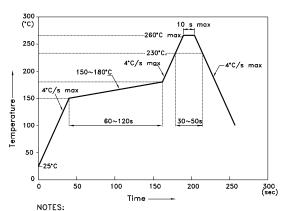


SPEC NO: DSAK7117 **REV NO: V.2** DATE: APR/18/2011 PAGE: 3 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: J.Yu ERP: 1203011220

APETD3528CGCK

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



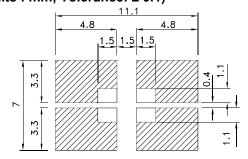
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

 3.Number of reflow process shall be 2 times or less.

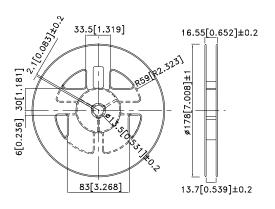
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

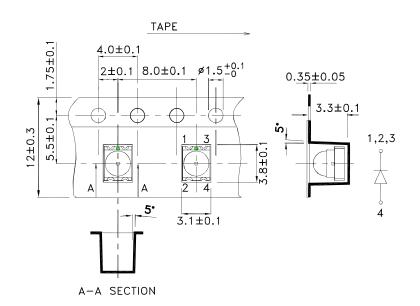


Solder resist

Tape Dimensions (Units: mm)

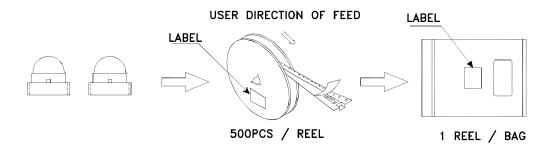
Reel Dimension

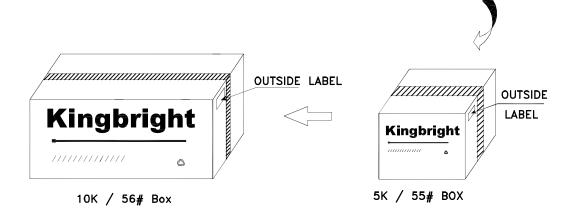


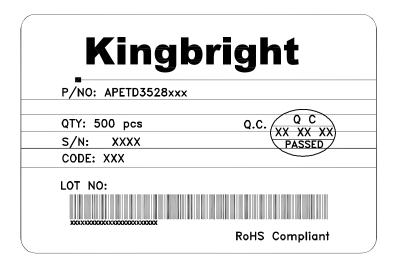


SPEC NO: DSAK7117 **REV NO: V.2 DATE: APR/18/2011** PAGE: 4 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: J.Yu ERP: 1203011220

PACKING & LABEL SPECIFICATIONS APETD3528CGCK







SPEC NO: DSAK7117 APPROVED: WYNEC

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PAGE: 5 OF 5 ERP: 1203011220